Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFD5C674NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX		
60 V	14.4 m Ω @ 10 V	40.4		
00 V	20.4 mΩ @ 4.5 V	42 A		

Value Unit Parameter Symbol v Drain-to-Source Voltage V_{DSS} 60 v Gate-to-Source Voltage V_{GS} ±20 Continuous Drain $T_{C} = 25^{\circ}C$ 35.2 A I_D Current $R_{\theta JC}$ (Notes 1, 2, 3) $T_{\rm C} = 100^{\circ}{\rm C}$ 24.9 Steady State Power Dissipation w T_C = 25°C P_D 37 R_{0.IC} (Notes 1, 2) $T_{\rm C} = 100^{\circ}{\rm C}$ 18 Continuous Drain $T_{\Delta} = 25^{\circ}C$ 10.1 А I_D Current R_{0JA} (Notes 1, 2, 3) 7.2 $T_A = 100^{\circ}C$ Steady State Power Dissipation P_D T_A = 25°C w 3.1 R_{0JA} (Notes 1 & 2) T_A = 100°C 1.5 119 **Pulsed Drain Current** $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ A I_{DM} Operating Junction and Storage Temperature T_J, T_{stg} -55 to °C + 175Source Current (Body Diode) ls 44 А Single Pulse Drain-to-Source Avalanche E_{AS} 61 mJ Energy (T_J = 25°C, $I_{L(pk)}$ = 1.6 A) °C Lead Temperature for Soldering Purposes T_L 260 (1/8'' from case for 10 s)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

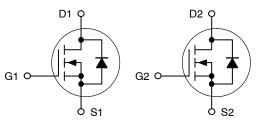
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	4.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	49	

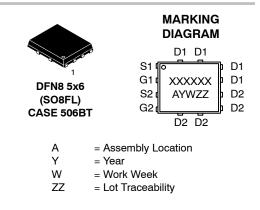
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.







ORDERING INFORMATION

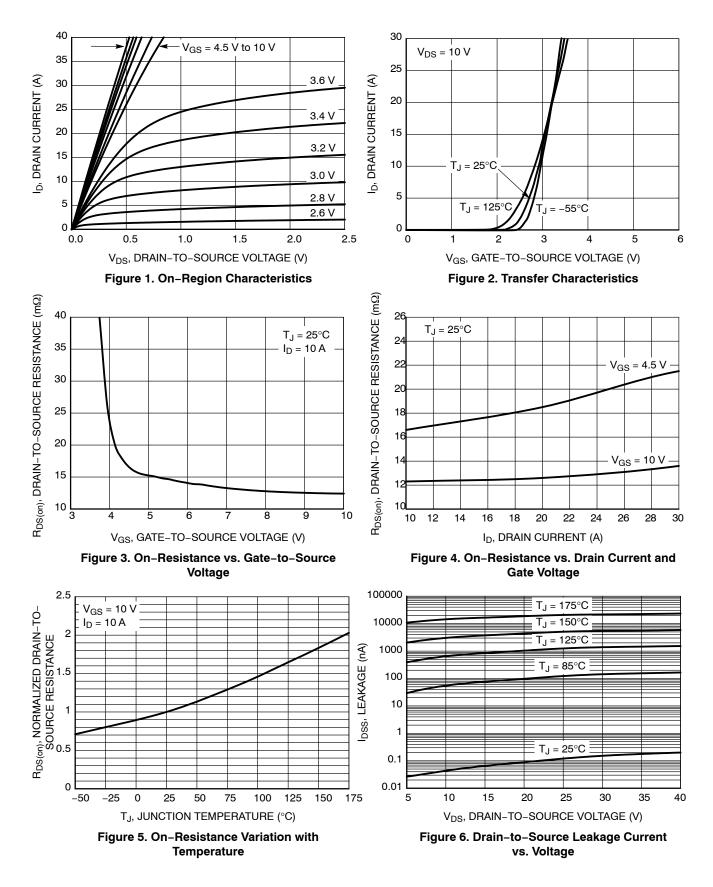
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

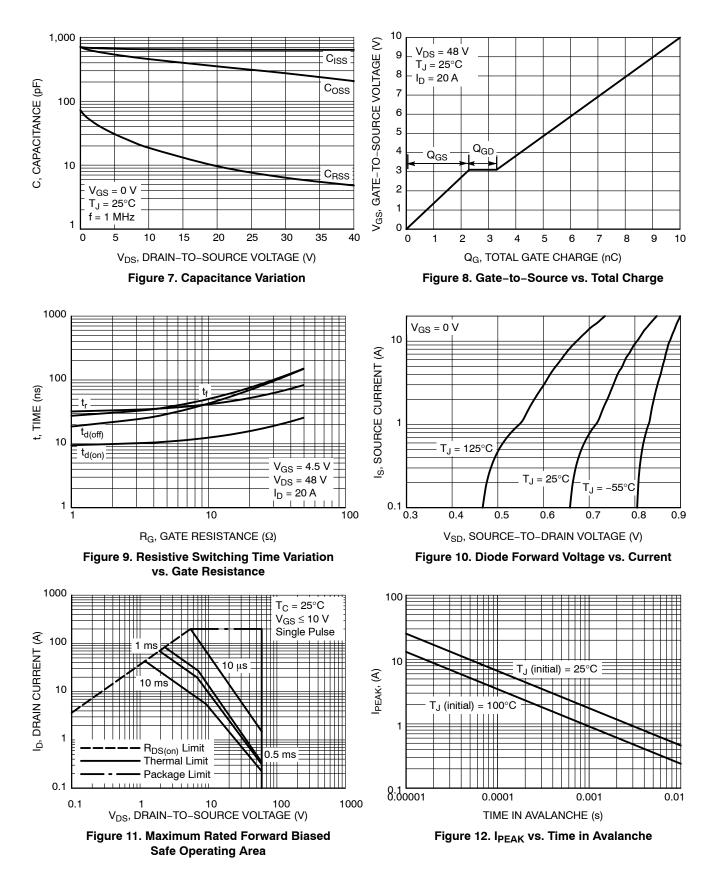
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-	-	-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				28		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	μΑ
		V _{DS} = 60 V	T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 25 \ \mu A$		1.2		2.2	V
Negative Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$	1			-4.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A		11.7	14.4	mΩ
		V _{GS} = 4.5 V	I _D = 10 A		16.4	20.4	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 10 A			27.5		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			640		pF
Output Capacitance	C _{OSS}				313		
Reverse Transfer Capacitance	C _{RSS}				7.7		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 20 A			4.7		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 20 A			10		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 10 A			1.4		nC
Gate-to-Source Charge	Q _{GS}				2.3		
Gate-to-Drain Charge	Q _{GD}				1.0		
Plateau Voltage	V _{GP}				3.1		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t _{d(ON)}				9.5		
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS}	s = 48 V,		32.1		1
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 5 \text{ A}, \text{ R}_{\rm G} = 1.0 \Omega$			18.6		- ns
Fall Time	t _f				27.5		
DRAIN-SOURCE DIODE CHARACTERISTIC	s				•		
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 A	T _J = 25°C		0.9	1.2	v
			T _J = 125°C		0.8		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 20 A/µs, I _S = 5 A			23.8		ns
Charge Time	t _a				11.5		
Discharge Time	t _b				12.3		
Reverse Recovery Charge	Q _{RR}				11.2		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Test: pulse width ≤ 300 µs, duty cycle ≤ 2%.
5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

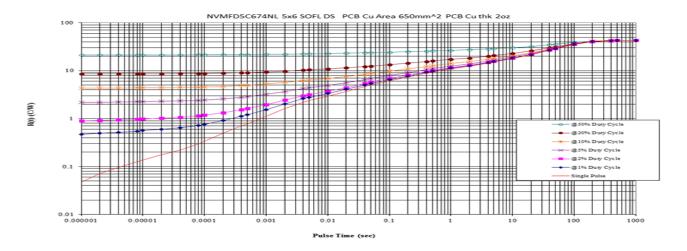


Figure 13. Thermal Characteristics

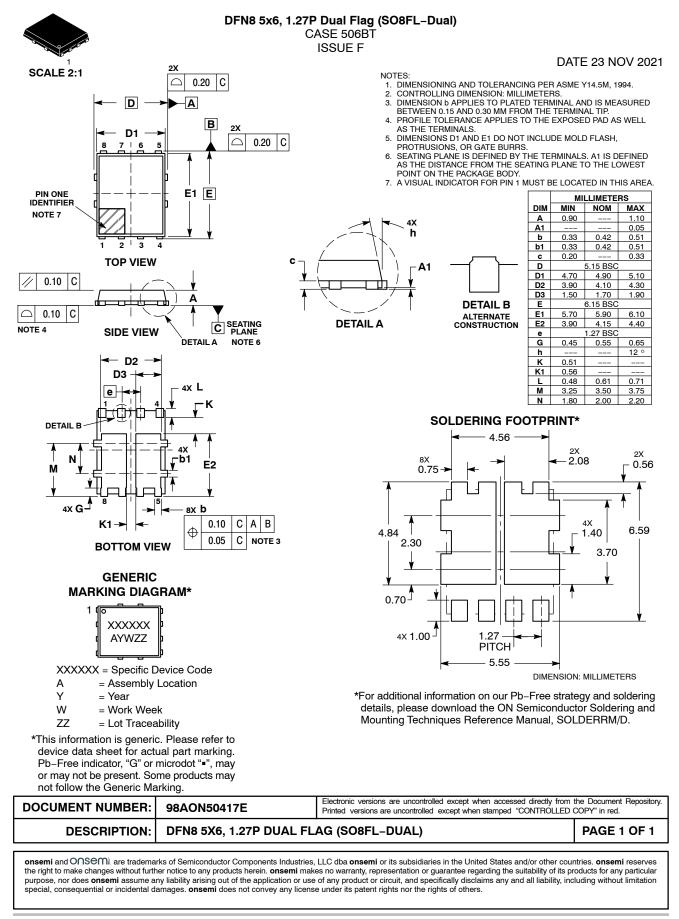
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFD5C674NLT1G	5C674L	DFN8 (Pb–Free)	1500 / Tape & Reel
NVMFD5C674NLWFT1G	674LWF	DFN8 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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